

PATENT ASSIGNMENT

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SUBMISSION TYPE:	NEW ASSIGNMENT										
NATURE OF CONVEYANCE:	ASSIGNMENT										
CONVEYING PARTY DATA											
<table border="1"> <thead> <tr> <th>Name</th> <th>Execution Date</th> </tr> </thead> <tbody> <tr> <td>JIAN BAI</td> <td>10/29/2012</td> </tr> </tbody> </table>		Name	Execution Date	JIAN BAI	10/29/2012						
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<table border="1"> <tr> <td>Name:</td> <td>HUIZHOU TCL MOBILE COMMUNICATION CO., LTD.</td> </tr> <tr> <td>Street Address:</td> <td>70 HUIFENG FOUR ROAD, ZHONGKAI HI-TECH DEVELOPMENT DISTRICT</td> </tr> <tr> <td>City:</td> <td>HUIZHOU CITY, GUANGDONG PROVINCE</td> </tr> <tr> <td>State/Country:</td> <td>CHINA</td> </tr> <tr> <td>Postal Code:</td> <td>516006</td> </tr> </table>		Name:	HUIZHOU TCL MOBILE COMMUNICATION CO., LTD.	Street Address:	70 HUIFENG FOUR ROAD, ZHONGKAI HI-TECH DEVELOPMENT DISTRICT	City:	HUIZHOU CITY, GUANGDONG PROVINCE	State/Country:	CHINA	Postal Code:	516006
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CORRESPONDENCE DATA											
Fax Number:	0000000000										
<i>Correspondence will be sent via US Mail when the fax attempt is unsuccessful.</i>											
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NAME OF SUBMITTER:	CHENG-JU CHIANG										
Total Attachments: 2 source=WISPRO-SZ-00094-Assignment#page1.tif source=WISPRO-SZ-00094-Assignment#page2.tif											

CH \$40.00 13811385

ASSIGNMENT

For good and valuable consideration, the receipt of which is hereby acknowledged, the undersigned inventor(s) (hereinafter as "ASSIGNOR") identified as below hereby sells, assigns, transfers, and sets over to Huizhou TCL Mobile Communication Co., Ltd of 70 Huifeng 4rd, ZhongKai Hi-tech Development District, Huizhou, Guangdong, China (hereinafter as "ASSIGNEE"), its successors and assigns, the entire right, title and interest in and to the invention known as METHOD OF IMPROVING ENERGY CONSUMPTION EFFICIENCY AND MOBILE TERMINAL THEREOF, AND USE OF THERMO-ELECTRIC CONVERSION MODULE (hereinafter as "INVENTION"), for which a United States Patent Application was executed concurrently herewith or, if not so executed, was:

- a. executed on (Date of Filing);
- b. filed on (Date of Filing), Application Serial No. (Application No.); or
- c. established by PCT International Patent Application No. PCT/CN2011/072236

and all rights and privileges under any Letters Patent which may be granted thereon, including all rights, if any, to sue for past infringement.

The ASSIGNOR hereby agrees without charge to said ASSIGNEE but at its expense to execute all necessary papers to be used in connection with the above-identified application and any additional, substitute, continuing, divisional, reexamination, or reissue applications, as the ASSIGNEE may deem necessary or expedient; to execute all papers in connection with any interference or other legal or quasi-legal proceedings relating to the above-identified application or any additional, substitute, continuing, divisional, reexamination, reissue applications thereof; to cooperate with the ASSIGNEE in every way possible in obtaining evidence and going forward in any such proceedings; and to perform all other affirmative acts which may be necessary or desirable to obtain a grant of a valid patent for said INVENTION.

The ASSIGNOR hereby agrees to communicate to the ASSIGNEE, or its representatives, any facts known to the ASSIGNOR respecting said INVENTION, and testify in any legal proceedings, sign all lawful papers, execute all necessary assignment papers to cause any and all Letters Patent to be issued to the ASSIGNEE, make all rightful oaths and generally do everything necessary or desirable to aid the ASSIGNEE, its successors and assigns, to obtain and enforce proper protection for said INVENTION.

The ASSIGNOR hereby authorizes and requests the Commissioner of the United States Patent and Trademark Office to issue any and all Letters Patent that may be granted upon any patent application for the INVENTION or any additional, substitute, continuing, or divisional applications thereof to the ASSIGNEE, its successors and assigns.

ASSIGNMENT (CONTINUED)

The ASSIGNOR hereby covenants and warrants that the ASSIGNOR has full right to convey the entire right, title and interest in and to said INVENTION by this assignment, free of any encumbrances and that no other agreement has been or will be executed in conflict herewith.

Signature of
Inventor 1 Bai Jian Executed Date 29/10/2002
Printed Name BAI, Jian
Residing at 70 Huifeng 4rd, ZhongKai Hi-tech Development District, Huizhou, Guangdong,
China